



- NOTES: A. All linear dimensions are in inches (mm).
 B. This drawing is subject to change without notice.
 C. 2 place decimals are ± 0.030 ($\pm 0,76$ mm).
 D. 3 place decimals are ± 0.010 ($\pm 0,25$ mm).
 E. Recommended keep out area for user components.
 F. Power pin connection should utilize two or more vias to the interior power plane of 0.025 (0,63) I.D. per input, ground and output pin (or the electrical equivalent).
 G. Paste screen opening: 0.080 (2,03) to 0.085 (2,16). Paste screen thickness: 0.006 (0,15).
 H. Pad type: Solder mask defined.
 I. This is a lead-free package. Finish - Tin (100%) over Nickel plate
 J. Dimension prior to reflow solder.
 K. Paste screen opening: 0.025 (0,63) x 0.064 (1,62). Paste screen thickness: 0.006 (0,15).

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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